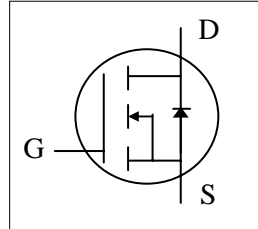


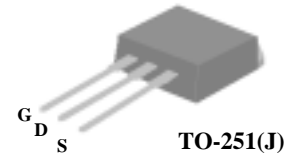
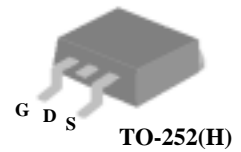
- ▼ Low Gate Charge
- ▼ Simple Drive Requirement
- ▼ Fast Switching



$BV_{DSS}$	30V
$R_{DS(ON)}$	80m $\Omega$
$I_D$	15A

**Description**

The TO-252 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters. The through-hole version (AP15N03J) is available for low-profile applications.



**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V	15	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V	9	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	50	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	28	W
	Linear Derating Factor	0.22	W/ $^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

**Thermal Data**

Symbol	Parameter	Value	Unit
Rthj-case	Thermal Resistance Junction-case	Max. 4.8	$^\circ C/W$
Rthj-amb	Thermal Resistance Junction-ambient	Max. 110	$^\circ C/W$



## AP15N03H/J

### Electrical Characteristics @ $T_j=25^{\circ}\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$\Delta BV_{DSS}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to $25^{\circ}\text{C}$ , $I_D=1\text{mA}$	-	0.037	-	$V/^{\circ}\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=8A$	-	-	80	$\text{m}\Omega$
		$V_{GS}=4.5V, I_D=6A$	-	-	100	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	3	V
$g_{fs}$	Forward Transconductance	$V_{DS}=10V, I_D=18A$	-	16	-	S
$I_{DSS}$	Drain-Source Leakage Current ( $T_j=25^{\circ}\text{C}$ )	$V_{DS}=30V, V_{GS}=0V$	-	-	1	$\mu A$
	Drain-Source Leakage Current ( $T_j=150^{\circ}\text{C}$ )	$V_{DS}=24V, V_{GS}=0V$	-	-	25	$\mu A$
$I_{GSS}$	Gate-Source Leakage	$V_{GS}=\pm 20V$	-	-	$\pm 100$	nA
$Q_g$	Total Gate Charge <sup>2</sup>	$I_D=8A$	-	4.6	-	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=24V$	-	1.1	-	nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	$V_{GS}=5V$	-	3	-	nC
$t_{d(on)}$	Turn-on Delay Time <sup>2</sup>	$V_{DS}=15V$	-	4.9	-	ns
$t_r$	Rise Time	$I_D=8A$	-	22.5	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.4\Omega, V_{GS}=10V$	-	12.2	-	ns
$t_f$	Fall Time	$R_D=1.9\Omega$	-	3.3	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V$	-	160	-	pF
$C_{oss}$	Output Capacitance	$V_{DS}=25V$	-	107	-	pF
$C_{rss}$	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	32	-	pF

### Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$I_S$	Continuous Source Current ( Body Diode )	$V_D=V_G=0V, V_S=1.3V$	-	-	15	A
$I_{SM}$	Pulsed Source Current ( Body Diode ) <sup>1</sup>		-	-	50	A
$V_{SD}$	Forward On Voltage <sup>2</sup>	$T_j=25^{\circ}\text{C}, I_S=15A, V_{GS}=0V$	-	-	1.3	V

#### Notes:

1. Pulse width limited by safe operating area.
2. Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .

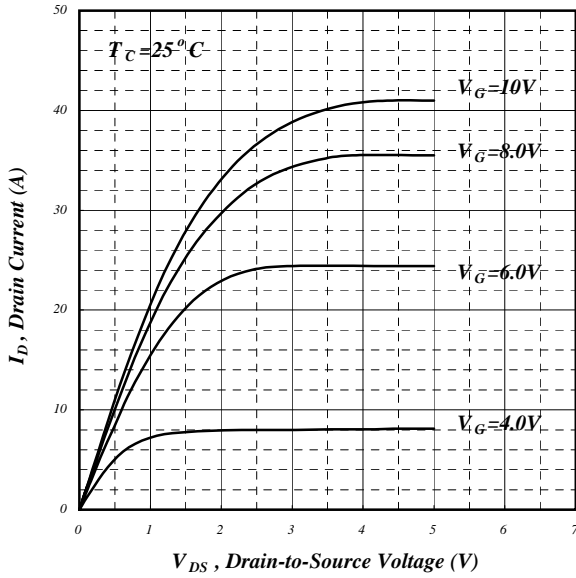


Fig 1. Typical Output Characteristics

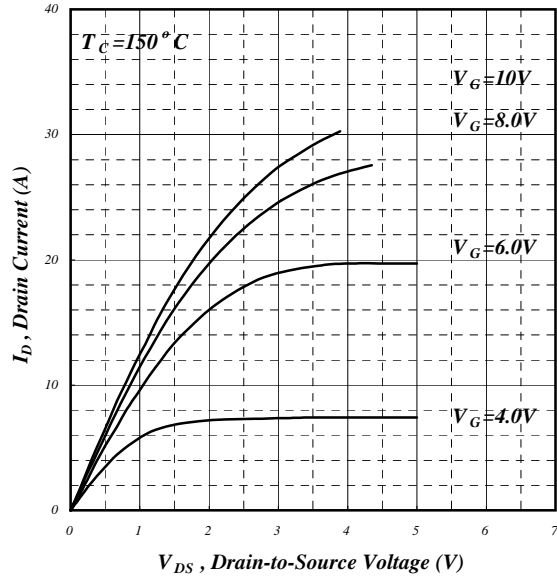


Fig 2. Typical Output Characteristics

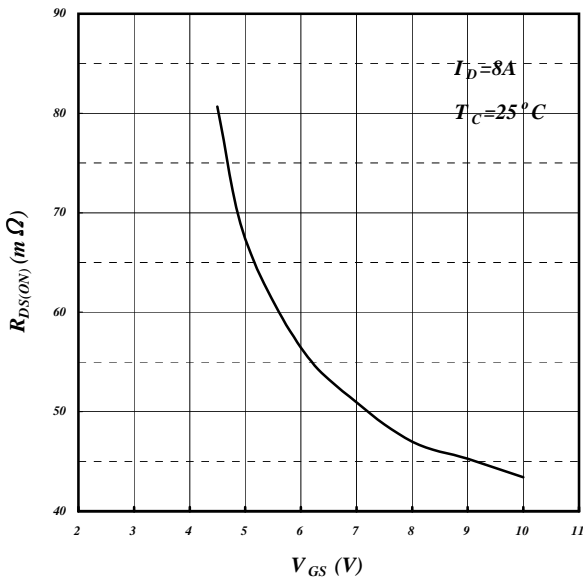


Fig 3. On-Resistance v.s. Gate Voltage

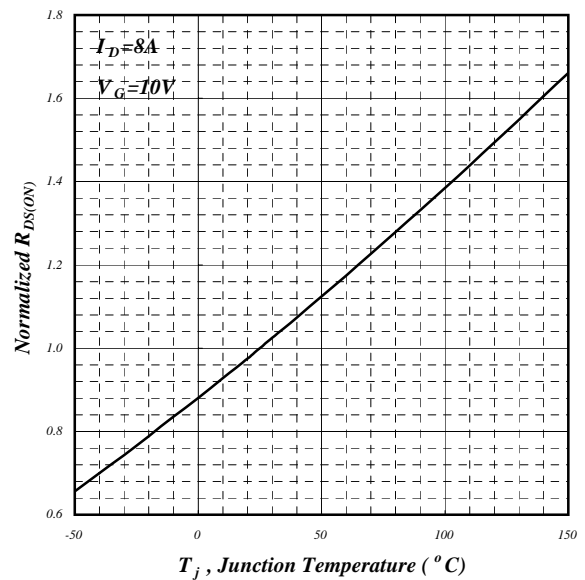


Fig 4. Normalized On-Resistance v.s. Junction Temperature

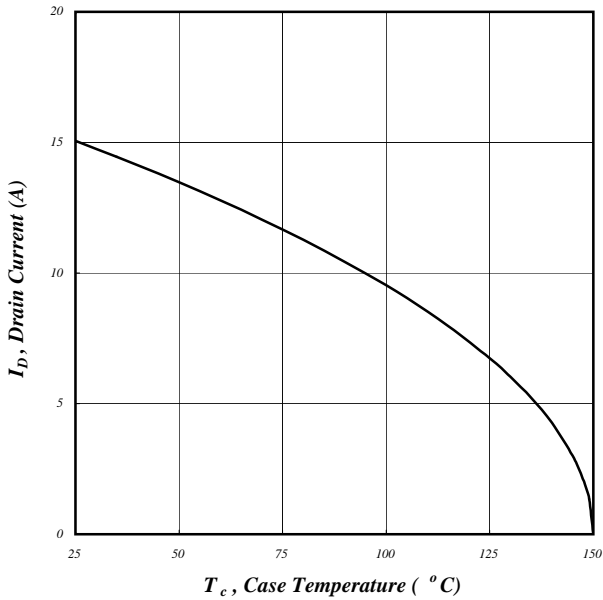


Fig 5. Maximum Drain Current v.s. Case Temperature

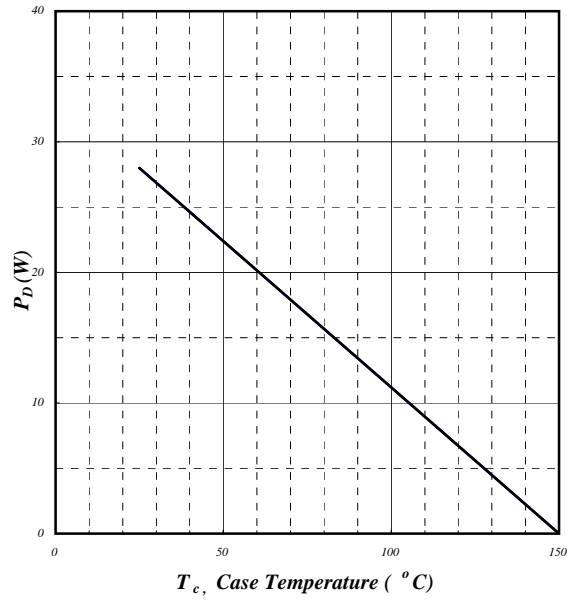


Fig 6. Typical Power Dissipation

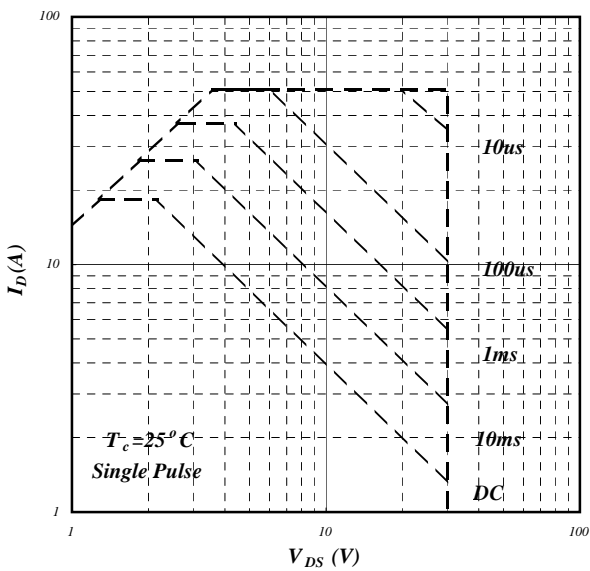


Fig 7. Maximum Safe Operating Area

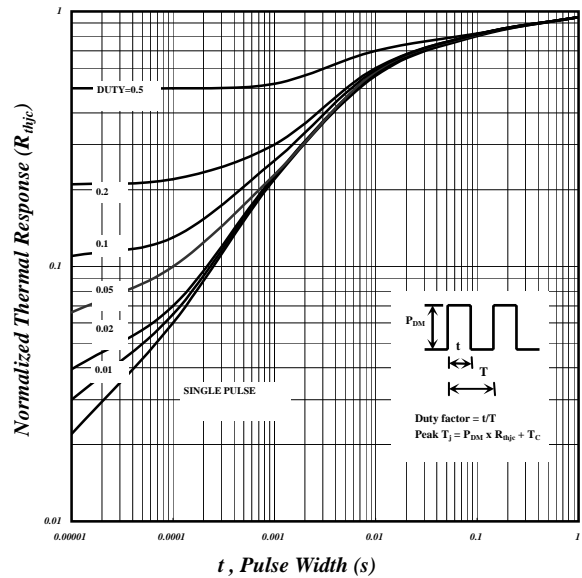


Fig 8. Effective Transient Thermal Impedance

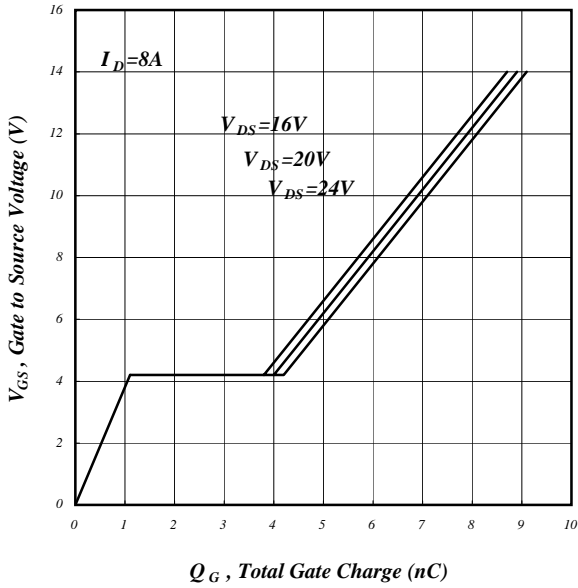


Fig 9. Gate Charge Characteristics

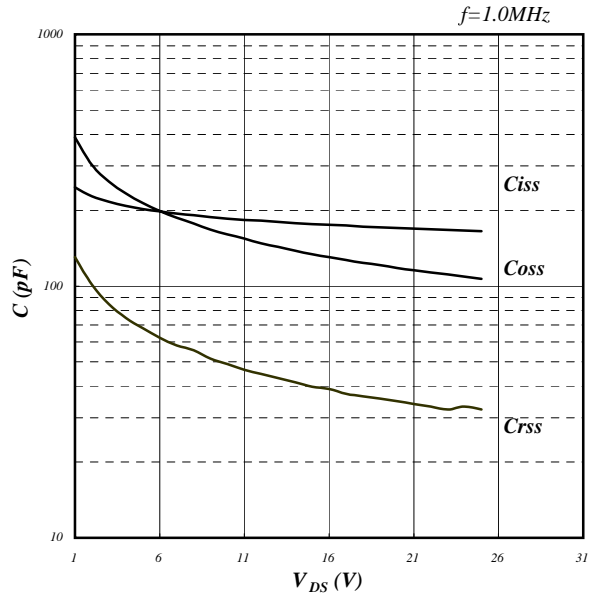


Fig 10. Typical Capacitance Characteristics

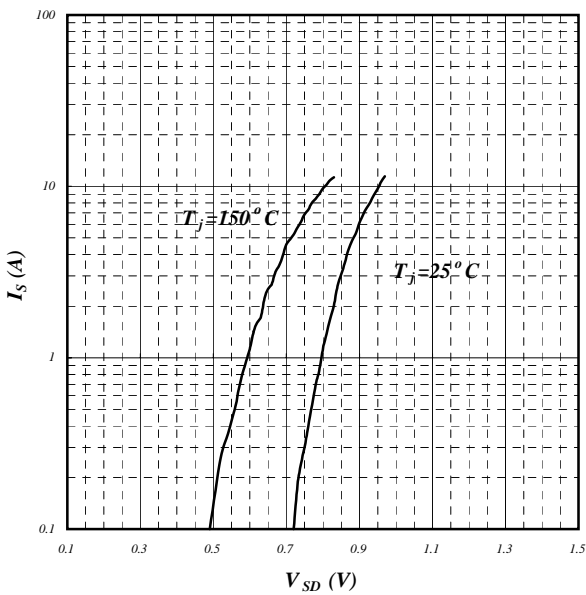


Fig 11. Forward Characteristic of Reverse Diode

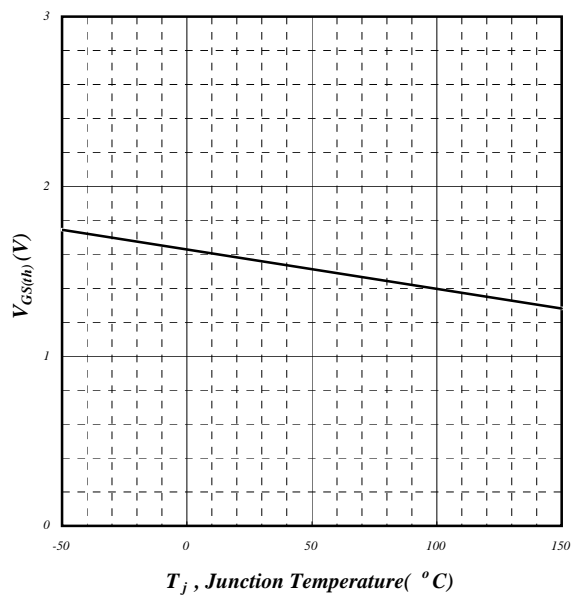


Fig 12. Gate Threshold Voltage v.s. Junction Temperature

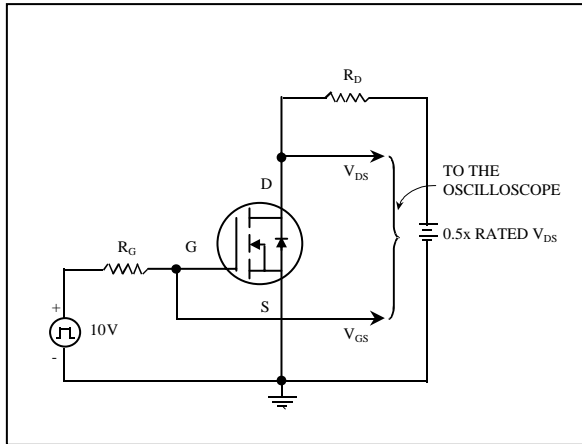


Fig 13. Switching Time Circuit

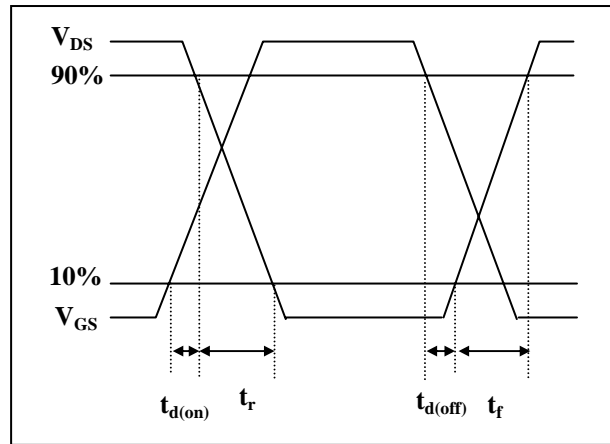


Fig 14. Switching Time Waveform

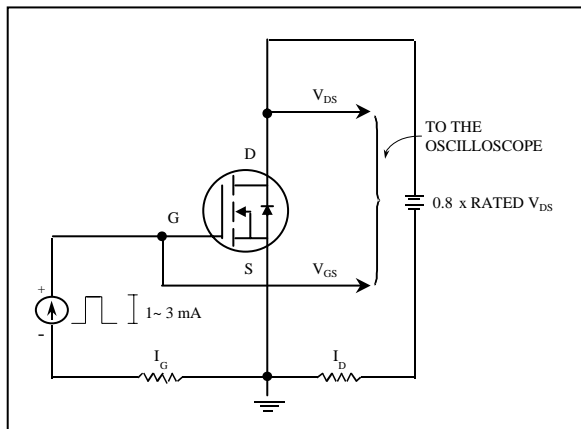


Fig 15. Gate Charge Circuit

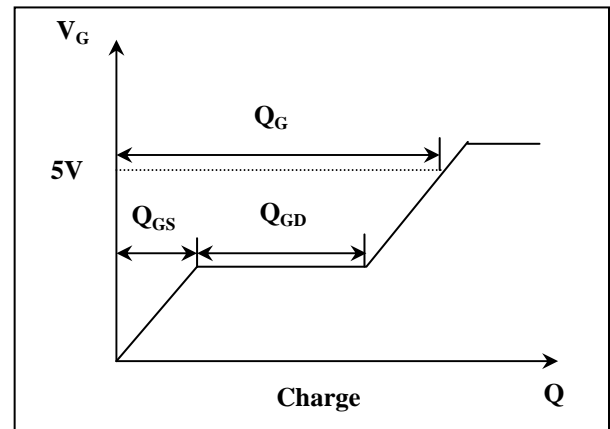


Fig 16. Gate Charge Waveform